

RoHS

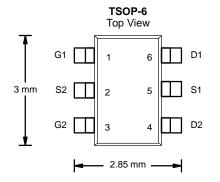
COMPLIANT

HALOGEN

FREE

Dual P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
- 20	0.075 at V_{GS} = - 4.5V	- 4.0	2.7 nC			
- 20	0.100 at V _{GS} = - 2.5 V	- 3.2	2.7 110			

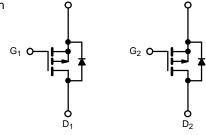


FEATURES

- Halogen-free According to IEC 61249-2-21 ٠ Definition
- TrenchFET[®] Power MOSFET ٠
- 100 % R_g Tested ٠
- Compliant to RoHS Directive 2002/95/EC ٠

APPLICATIONS

- Load Switch for Portable Applications
- Battery Switch for Portable Devices
- Computers
- Bus Switch
- Load Switch



Р

Channel	MOOFET
P-Channel	NUSFEI

S₁

MOSFET

 S_2

D Channel	•
P-Channel	N

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 20	V	
Gate-Source Voltage		V _{GS}	± 12	V	
	T _C = 25 °C		- 4.0		
Continuous Drain Current (T. 150 °C)	T _C = 70 °C		- 3.3		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	- 3.6 ^{b, c}		
	T _A = 70 °C	1	-3.1 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	- 12		
	T _C = 25 °C		- 1.17		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 0.95 ^{b, c}		
	T _C = 25 °C		1.4		
Maximum Dower Dissinction	T _C = 70 °C		0.9	10/	
Maximum Power Dissipation	T _A = 25 °C	P _D	1.14 ^{b, c}	W	
	T _A = 70 °C	1	0.73 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	$t \le 5 s$	R _{thJA}	93	110	°C/W	
Maximum Junction-to-Foot	Steady State	R _{thJF}	75	90	0/11	

Notes:

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 150 °C/W.

a. T_C = 25 °C.

SPECIFICATIONS ($T_J = 25 \text{ °C}$,					T	T
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	-				1	•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 20			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	- J I _D = - 250 μA		- 17		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	10 - 200 p. (3.5		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.5		- 2.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$			1 10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}$	- 8			A
	D(011)	V _{GS} = - 4.5V, I _D = - 2.5 A	-	0.075		- Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -1 \text{ A}$		0.100		
Forward Transconductance ^a	g _{fs}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.6 \text{ A}$		5		S
Dynamic ^b					1	
Input Capacitance	C _{iss}			210		1
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		45		pF
Reverse Transfer Capacitance	C _{rss}			33		
		V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 2.6 A		5.2	8	
Total Gate Charge	Qg			2.7	4	nC
Gate-Source Charge	Q _{gs}	V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 2.6 A		0.94		
Gate-Drain Charge	Q _{gd}			1.3		
Gate Resistance	R _g	f = 1 MHz	2	7	14	Ω
Turn-On Delay Time	t _{d(on)}			39	59	
Rise Time	t _r	V_{DD} = - 10 V, R _L = 7.1 Ω		25	38	-
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 2.1 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		13	20	
Fall Time	t _f			9	18	
Turn-On Delay Time	t _{d(on)}			5	10	ns
Rise Time	t _r	V_{DD} = - 10 V, R _L = 7.1 Ω		10	20	-
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -2.1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		14	21	
Fall Time	t _f			7	14	
Drain-Source Body Diode Characteristic					1	
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			1.17	
Pulse Diode Forward Current	I _{SM}				8	A
Body Diode Voltage	V _{SD}	I _S = - 2.1 A, V _{GS} = 0 V		0.85	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			13	20	ns
Body Diode Reverse Recovery Charge	Q _{rr}			6	12	nC
Reverse Recovery Fall Time	ta	I _F = - 2.1 A, dl/dt = 100 A/μs, T _J = 25 °C		9		
Reverse Recovery Rise Time	t _b			4		ns

Notes:

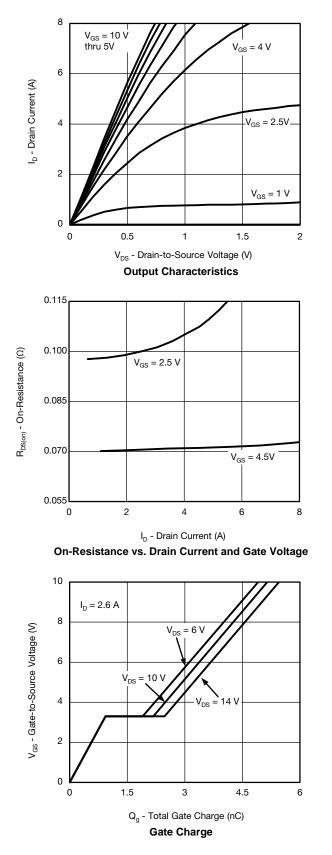
a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

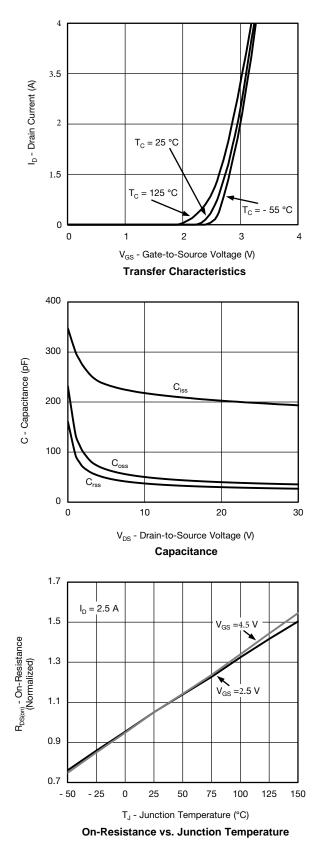
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

emi



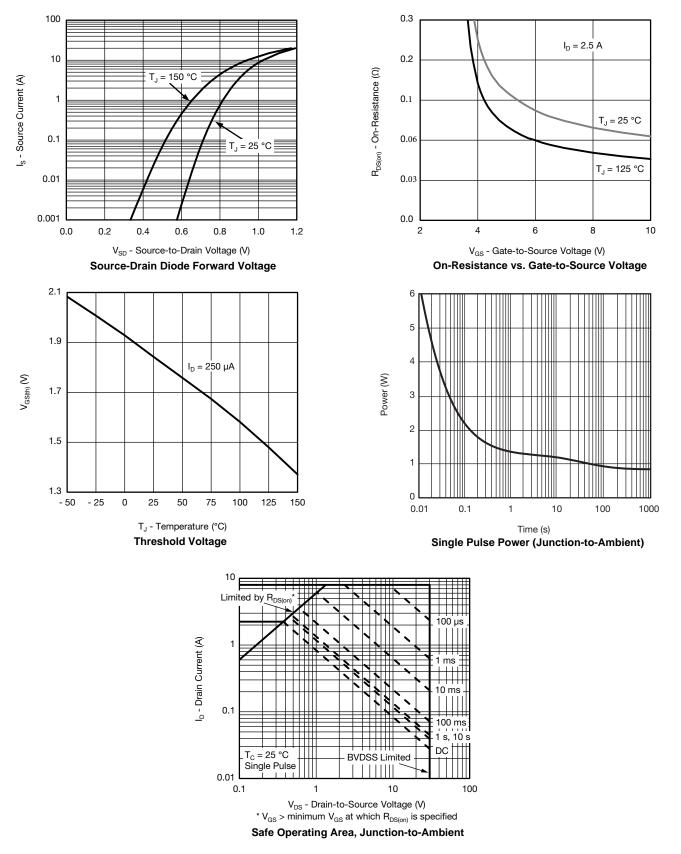
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





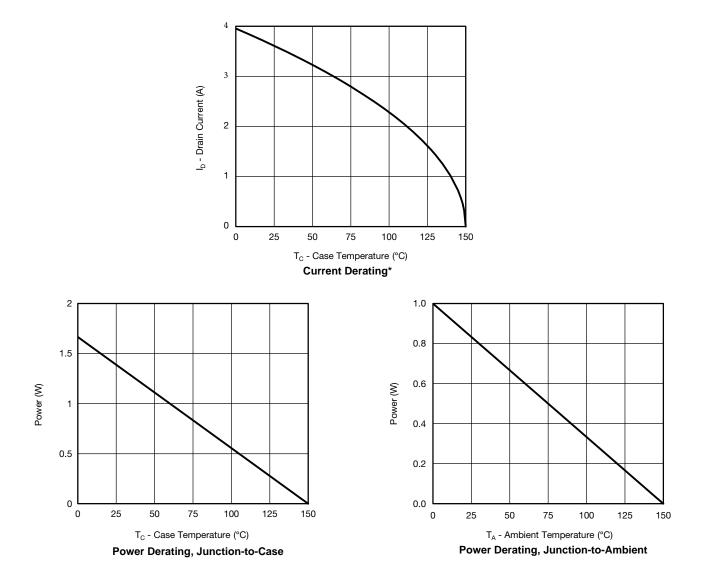




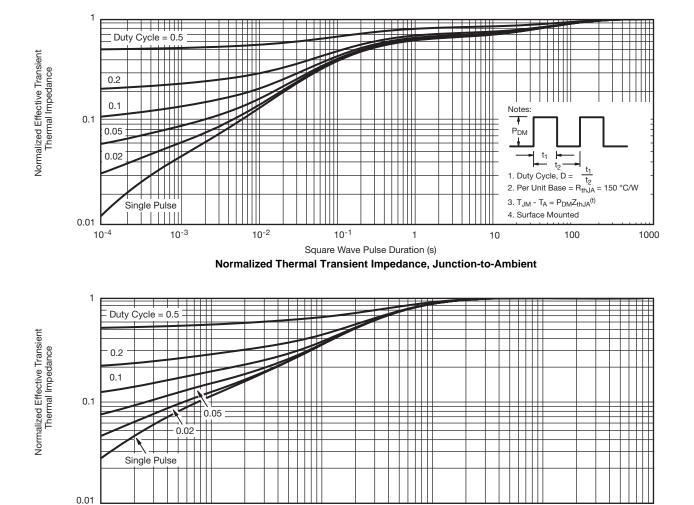




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



10-2

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Foot

10-1

1

10

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

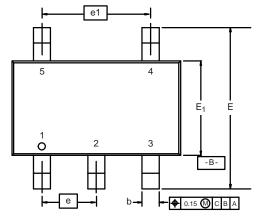
10⁻³

10-4

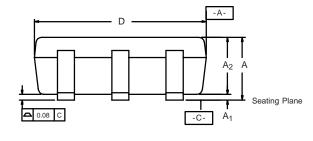


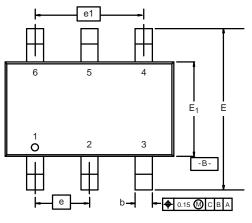


TSOP: 5/6–LEAD JEDEC Part Number: MO-193C

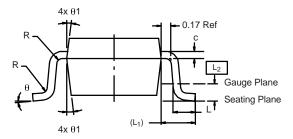








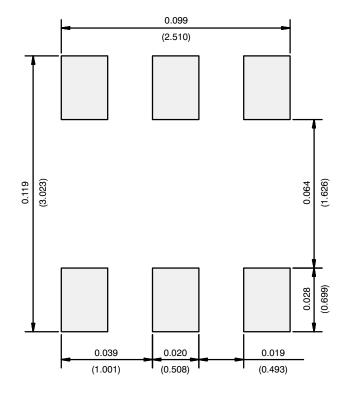
6-LEAD TSOP



	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.91	-	1.10	0.036	-	0.043	
A ₁	0.01	-	0.10	0.0004	-	0.004	
A ₂	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
Е	2.70	2.85	2.98	0.106	0.112	0.117	
E ₁	1.55	1.65	1.70	0.061	0.065	0.067	
е		0.95 BSC		0.0374 BSC			
e ₁	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L ₁		0.60 Ref			0.024 Ref		
L ₂	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ	7° Nom 7° Nom						
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							



RECOMMENDED MINIMUM PADS FOR TSOP-6



Recommended Minimum Pads Dimensions in Inches/(mm)



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